

IEI Technology Corp .

MODEL: ECW-281B/B2-D525

IEI Intel® AtomTM Fanless Embedded System

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H.D.D

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RoHS Compliant, Dual GbE LAN, COM Ports, USB 2.0

User Manual



Rev. 1.03 19 October, 2012



Revision

Date	Version	Changes	
19 October, 2012	1.03	Added bottom cover screw torque warning	
24 October, 2011	1.02	Modified COM port locations in Section 2.3.2	
		Updated Chapter 5: BIOS	
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WARNING

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This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) this device may not cause harmful interference, and(2) this device must accept any interference received, including interference that may cause undesired operation.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures: —Reorient or relocate the receiving antenna.

-Increase the separation between the equipment and receiver.

-Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

-Consult the dealer or an experienced radio/ TV technician for help.

You are cautioned that any change or modifications to the equipment not expressly approve by the party responsible for compliance could void your authority to operate such equipment.

IMPORTANT NOTE:

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

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Introduction





1.1 Overview



Figure 1-1: ECW-281B/B2-D525 Series Embedded System

There are four WAFER-PV-D5252 Intel® Atom[™] based embedded solutions in the ECW-281B/B2-D525 series. All fanless motherboards have been optimized for multimedia applications that require minimum installation space. The WAFER-PV-D5252 motherboard supports a full range of functions for an AT/ATX-compatible industrial computer. ECW-281B/B2-D525 embedded subsystems are all capable of supporting one 2.5" SATA hard disk drive. The W models also have a built-in 802.11 b/g/n wireless module.

1.1.1 Benefits

The ECW-281B/B2-D525 embedded system has the following benefits:

- Easy installation saves installation time
- Complete integration saves solution development time and cost
- Secure storage with one SATA hard drive supported
- Compact size saves space
- Powerful preinstalled Intel® Atom™ D525 CPU and motherboard ensures rigorous processing needs can be met

1.1.2 Features

The ECW-281B/B2-D525 has the following features

- RoHS compliant design
- Fanless system
- 1.8 GHz Intel® Atom™ D525 CPU supported

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- Dual GbE LAN for high speed network applications
- One SATA hard drive supported
- Wall mount and DIN mount supported.

1.2 Model Variations

There are six models in the ECW-281B/B2-D525 embedded system series. The six models are all preinstalled with an Intel® Atom[™] D525 processor and 1 GB DDR3 memory. The model variations are listed in **Table 1-1** below.

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ECW-281B Series	Power	Wireless	VGA	COM Ports
ECW-281B-R10/D525/1GB	12V DC input	No	1 x VGA	5 x RS-232
	(60 W adaptor)			1 x RS-232 or
ECW-281BW-R10/D525/1GB	12V DC input	Yes		optional RS-422/485
	(60 W adaptor)			
ECW-281BWD-R10/D525/1GB	9V~36V DC input	No		
ECW-281BWDW-R10/D525/1GB	9V~36V DC input	Yes		
ECW-281B2 Series	Power	Wireless	VGA	COM Ports
ECW-281B2 Series ECW-281B2-R10/D525/1GB	Power 12V DC input	Wireless No	VGA 2 x VGA	COM Ports 5 x RS-232
ECW-281B2 Series ECW-281B2-R10/D525/1GB	Power 12V DC input (60 W adaptor)	Wireless No	VGA 2 x VGA	5 x RS-232
ECW-281B2 Series ECW-281B2-R10/D525/1GB ECW-281B2W-R10/D525/1GB	Power 12V DC input (60 W adaptor) 12V DC input	Wireless No Yes	VGA 2 x VGA	COM Ports 5 x RS-232
ECW-281B2 Series ECW-281B2-R10/D525/1GB ECW-281B2W-R10/D525/1GB	Power 12V DC input (60 W adaptor) 12V DC input (60 W adaptor)	Wireless No Yes	VGA 2 x VGA	5 x RS-232
ECW-281B2 Series ECW-281B2-R10/D525/1GB ECW-281B2W-R10/D525/1GB ECW-281B2WD-R10/D525/1GB	Power 12V DC input (60 W adaptor) 12V DC input (60 W adaptor) 9V~36V DC input	Wireless No Yes No	VGA 2 x VGA	5 x RS-232

Table 1-1: Model Variations





1.3 Technical Specifications

The specifications for the Intel based embedded systems are listed below.

	ECW-281B-D525	ECW-281B2-D525	
СРИ	Preinstalled 1.8 GHz Intel® Atom™ Processor D525 with 1 MB L2 cache		
System Chipset	Intel® ICH8M		
System Memory	Preinstalled 1.0 GB DDR3 SDRAM SO-	DIMM (system max. 2 GB)	
Ethernet	Dual Realtek RTL8111E GbE controllers		
	Built-in 802.11 b/g/n wireless module for	the wireless models	
Display	One VGA port	Two VGA port	
		 VGA1: 2048 x 1536 (max.) VGA0: 4004 x 700 (max.) 	
Serial Port		• VGA2: 1024 X 768 (max.)	
	Five R5-232	FIVE RS-232	
	One RS-232 or RS-422/485 (optional)		
USB	Four USB 2.0 ports		
Audio	One audio out		
Storage	One 2.5" SATA hard drive supported		
	One internal CF card slot		
Chassis Construction	Aluminum Alloy		
Power Supply	9 V – 36 V DC (WD series models):		
	Internal DC-to-DC power converter		
	12 V DC models:		
	External power adapter, 90V AC ~ 264V AC @ 47Hz ~ 63Hz, 60 W		
Operating Shock	Half-sine wave shock 3G; 11ms; 3 shocks per axis		
Operating Vibration	MIL-STD-810F 514.5C-1 (HDD)		
	MIL-STD-810F 514.5C-2 (CF)		

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Operating Temperature	-20°C ~ 65°C with SATA SSD, air flow*	
	-10°C ~ 50°C with SATA HDD in wireless model, air flow*	
	*Ambient air speed per IEC-68-2-2 standard	
Color	Black	
Mounting	DIN mount	
	VESA MIS-D 75 wall mount	
Weight (Net/Gross)	2.1 kg/3.9 kg	
Dimensions (D x W x H)	132 mm x 229 mm x 64 mm	
EMC	FCC Class A, CE	

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Table 1-2: Technical Specifications





1.4 Power Module Specifications (Optional)

A DC-to-DC power module is preinstalled in the WD series model to provide 9 V~36 V power input. The specifications for the IDD-936260A are shown in **Table 1-3**.

Model Name:	IDD-936260A	
Input	9 V DC~36 V DC	
Output:		
12V	3 A (Max.)	
5V	10 A (Max.)	
5VSB	0.5 A (Max.)	
Max. Total Output:	60 W	
Performance Characteristics:		
Noise & Ripple: < 240 mV		
Line Regulation:	< 20 mV	
Load Regulation	<60 mV	
Efficiency:	Up to 90%	
Dimensions:	40 mm x 100 mm	
Weight:	58 g	
Operating Temperature:	-40°C~85°C	

Table 1-3: DC-to-DC Power Module Specifications

1.5 Power Adapter (Optional)

The ECW-281B/B2-D525 series models that feature 12 V DC input are shipped with a 60W power adapter.

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Figure 1-2: Power Adapter

The specifications for the adapter are listed in Table 1-4:

Input Voltage	90 V ~ 264 V AC
Input Frequency	47 Hz ~ 63 Hz
Output Voltage	12 V
Output Current	5 A
Efficiency	87%
Operating Temperature	0 °C ~ 40 °C
Storage Temperature	-20 °C ~ 65 °C

Table 1-4: Power Adapter Specifications







Mechanical Description



2.1 Mechanical Overview

The ECW-281B/B2-D525 RoHS compliant, Intel® Atom[™] fanless embedded system features industrial grade components that offer longer operating life, high shock/vibration resistance and endurance over a wide temperature range. The ECW-281B/B2-D525 combines these features in an aluminum enclosure. Featuring two LAN, four USB, six serial communication ports, as well as audio, and VGA, the ECW-281B/B2-D525 offers system integrators and developers the best selection of robust and high performance computing system platforms. An internal bracket supports one 2.5" SATA hard drives.

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2.2 Physical Dimensions

The dimensions of the ECW-281B/B2-D525 are listed below and shown in Figure 2-1.

- Height: 64.00 mm
- Width: 229.00 mm
- Length: 132.00 mm







Figure 2-1: ECW-281B/B2-D525 Dimensions (mm)





2.3 External Overview

2.3.1 Front Panel

The ECW-281B/B2-D525 front panel contains:

- 2 x USB port connectors
- 1 x HDD LED indicator
- 1 x Power button

An overview of the front panel is shown in **Figure 2-2** below.



Figure 2-2: ECW-281B/B2-D525 Front Panel

2.3.2 Rear Panel

2.3.2.1 ECW-281B-D525 Rear Panel

The rear panel of the ECW-281B-D525 provides access to the following external I/O connectors.

- 2 x USB port connectors
- 2 x RJ-45 Ethernet connector
- 1 x VGA connector
- 1 x RS-232/422/485 serial port (Default: RS-232)
- 5 x RS-232 serial ports
- 1 x Speaker out
- 1 x 3-pin power terminal block
- 1 x 12V DC power jack



1 x Wireless antenna connector (for wireless models only)

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An overview of the rear panel is shown in Figure 2-3.



Figure 2-3: ECW-281B-D525 Rear Panel

2.3.2.2 ECW-281B2-D525 Rear Panel

The rear panel of the ECW-281B2-D525 provides access to the following external I/O connectors.

- 2 x USB port connectors
- 2 x RJ-45 Ethernet connector
- 2 x VGA connectors
- 5 x RS-232 serial ports
- 1 x Speaker out
- 1 x 3-pin power terminal block
- 1 x 12V DC power jack
- 1 x Wireless antenna connector (for wireless models only)

An overview of the rear panel is shown in Figure 2-4.







Figure 2-4: ECW-281B2-D525 Rear Panel

2.3.3 Bottom Surface



Never remove the bottom access panel from the chassis while power is still being fed into the system. Before removing the bottom access panel, make sure the system has been turned off and all power connectors unplugged.

The bottom surface of the ECW-281B/B2-D525 contains the retention screw holes for the VESA MIS-D 100 wall-mount kit, two-side mounting brackets and DIN mount bracket.



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2.4 Internal Overview

The ECW-281B/B2-D525 internal components are listed below:

- 1 x IEI WAFER motherboard (preinstalled)
- 1 x IEI power module (WD modesls only)
- 1 x SO-DIMM module (preinstalled)
- 1 x Hard drive bracket and SATA cable support one SATA hard disk

All the components are accessed by removing the bottom surface.











System Components







The jumpers and connectors shown in the section below are those jumpers and connectors that are relevant to the configuration and installation of the embedded system. For a complete list of jumpers and connectors on the WAFER-PV-D5252 motherboard, please refer to the WAFER-PV-D5252 user manual.

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The ECW-281B/B2-D525 models have a WAFER-PV-D5252 motherboard installed in the system. The following sections describe the relevant connectors and jumpers on the motherboard.

3.1.1 WAFER-PV-D5252 Motherboard Overview

The locations of the WAFER-PV-D5252 jumpers and connectors used on the ECW-281B/B2-D525 are shown in **Figure 3-1** below.



Figure 3-1: WAFER-PV-D5252 Jumper and Connector Locations





3.1.2 CPU Support



The ECW-281B/B2-D525 series has a preinstalled Intel® Atom[™] 1.8 GHz CPU on-board. If the CPU fails, the motherboard has to be replaced. Please contact the IEI reseller or vendor you purchased the ECW-281B/B2-D525 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to sales@iei.com.tw.

The ECW-281B/B2-D525 comes with an embedded 45 nm 1.8 GHz Intel® Atom[™] processor D525. It is a dual-core processor with 1 MB L2 cache.

3.2 Peripheral Interface Connectors

Section 3.2.1 lists all the peripheral interface connectors seen in Section 3.1.1.

3.2.1 Peripheral Interface Connectors

Table 3-1 shows a list of the peripheral interface connectors on the WAFER-PV-D5252 that are used for the ECW-281B/B2-D525. Detailed descriptions of these connectors can be found in **Section 3.3**.

Connector	Туре	Label
ATX power connector	4-pin ATX	J1
Audio connector	10-pin box header	AUDIO1
Battery connector	2-pin wafer	BT1
CompactFlash® socket	50-pin CF socket	CF1
LED connector	6-pin header	CN2
PCIe Mini Card slot	PCIe Mini Slot	CN1

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Power button connector	2-pin wafer	PWR_BTN
Reset button connector	2-pin header	RST_BTN
Serial ATA (SATA) drive connectors	7-pin SATA	SATA1
RS-232 serial port connector (COM3 – COM6)	40-pin header	СОМ
RS-232/422/485 serial port connector	14-pin header	COM2
USB 2.0 connector	8-pin header	USB4

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Table 3-1: Peripheral Interface Connectors

3.3 Internal Peripheral Connectors

Internal peripheral connectors are found on the motherboard and are only accessible when the motherboard is outside of the chassis. This section has complete descriptions of the internal, peripheral connectors on the WAFER-PV-D5252 that are used for the ECW-281B/B2-D525.

3.3.1 ATX Power Connector

CN Label:	J1
СN Туре:	4-pin power connector (1x4)
CN Location:	See Figure 3-2
CN Pinouts:	See Table 3-2

The 4-pin ATX power connector is connected to a DC-DC power module.



Figure 3-2: ATX Power Connector Location



PIN NO.	DESCRIPTION
1	GND
2	GND
3	+12V
4	+5V

Table 3-2: ATX Power Connector Pinouts

3.3.2 Audio Connector (10-pin)

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CN Label:	AUDIO1	
CN Type:	10-pin box header	
CN Location:	See Figure 3-3	
CN Pinouts:	See Table 3-3	

The 10-pin audio connector is interfaced to an audio line-out connector and provides output of audio signals from the system.



Figure 3-3: Audio Connector Pinouts (10-pin)

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	LINE_OUTR	2	LINEIN_R
3	GND_AUDIO	4	GND_AUDIO
5	LINE_OUTL	6	LINEIN_L
7	GND_AUDIO	8	GND_AUDIO
9	MICIN	10	MICIN

Table 3-3: Audio Connector Pinouts (10-pin)

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3.3.3 CompactFlash® Socket

CN Label:	CF1
CN Type:	50-pin header (2x25)
CN Location:	See Figure 3-4
CN Pinouts:	See Table 3-4

A CF Type I or Type II memory card is inserted to the CF socket on the solder side of the ECW-281B/B2-D525.



Figure 3-4: CF Card Socket Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	GND	26	CD1#
2	D3	27	D11
3	D4	28	D12
4	D5	29	D13
5	D6	30	D14
6	D7	31	D15
7	CE#	32	CE2#
8	A10	33	VS1#
9	OE#	34	IOR#
10	A9	35	IOW#
11	A8	36	WE#



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PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
12	A7	37	IRQ
13	VCC	38	VCC
14	A6	39	CSEL#
15	A5	40	VS2#
16	A4	41	RESET#
17	A3	42	WAIT#
18	A2	43	INPACK#
19	A1	44	REG#
20	AO	45	BVD2
21	DO	46	BVD1
22	D1	47	D8
23	D2	48	D9
24	IOCS16#	49	D10
25	CD2#	50	GND2

Table 3-4: CF Card Socket Pinouts

3.3.4 LED Connector

CN Label:	CN2
СN Туре:	6-pin wafer (1x6)
CN Location:	See Figure 3-5
CN Pinouts:	See Table 3-5

The LED connector connects to an HDD indicator LED and a power LED on the system chassis to inform the user about HDD activity and the power on/off status of the system.





Figure 3-5: LED Connector Locations

	Pin	Description
+5 V Power Output	1	+5 V
	2	GND
Power LED	3	VCC
	4	GND
HDD LED	5	VCC
	6	-HDLED

Table 3-5: LED Connector Pinouts

3.3.5 PCIe Mini Card Slot

CN Label:	CN1
CN Type:	52-pin Mini PCIe Card Slot
CN Location:	See Figure 3-6
CN Pinouts:	See Table 3-6

The PCIe mini card slot enables a PCIe mini card expansion module to be connected to the board. Cards supported include among others wireless LAN (WLAN) cards.







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Figure 3-6: PCIe Mini Card Slot Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	PCIE_WAKE#	2	VCC3
3	N/C	4	GND
5	N/C	6	1.5V
7	CLKREQ#	8	LFRAME#
9	GND	10	LAD3
11	CLK-	12	LAD2
13	CLK+	14	LAD1
15	GND	16	LADO
17	PCIRST#	18	GND
19	LPC	20	VCC3
21	GND	22	PCIRST#
23	PERN2	24	3VDual
25	PERP2	26	GND
27	GND	28	1.5V
29	GND	30	SMBCLK
31	PETN2	32	SMBDATA
33	PETP2	34	GND
35	GND	36	USBD-
37	N/C	38	USBD+
39	N/C	40	GND
41	N/C	42	N/C
43	N/C	44	RF_LINK#
45	N/C	46	BLUELED#
47	N/C	48	1.5V
49	N/C	50	GND

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51	N/C	52	VCC3
----	-----	----	------

Table 3-6: PCIe Mini Card Slot Pinouts

3.3.6 Power Button Connector

CN Label:	PWR_BTN
CN Type:	2-pin wafer (1x2)
CN Location:	See Figure 3-7
CN Pinouts:	See Table 3-7

The power button connector is connected to a power switch on the system chassis to enable users to turn the system on and off.

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Figure 3-7: Power Button Connector Location

PIN NO.	DESCRIPTION
1	Power Switch-
2	GND

Table 3-7: Power Button Connector Pinouts

3.3.7 Reset Button Connector

CN Label:	RST_BTN
СN Туре:	2-pin wafer (1x2)
CN Location:	See Figure 3-8




CN Pinouts: See Table 3-8

The reset button connector is connected to a reset switch on the system chassis to enable users to reboot the system when the system is turned on.



Figure 3-8: Reset Button Connector Locations

PIN NO.	DESCRIPTION
1	Reset Switch
2	GND

Table 3-8: Reset Button Connector Pinouts

3.3.8 SATA Drive Connectors

CN Label:	SATA1, SATA2
CN Type:	7-pin SATA drive connectors
CN Location:	See Figure 3-9
CN Pinouts:	See Table 3-9

The SATA connectors connect to SATA hard drives or optical drives.



Figure 3-9: SATA Drive Connector Locations

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PIN NO.	DESCRIPTION
1	GND
2	TX+
3	TX-
4	GND
5	RX-
6	RX+
7	GND

Table 3-9: SATA Drive Connector Pinouts

3.3.9 Serial Port Connector (COM3, COM4, COM5 and COM6)

CN Label:	СОМ
CN Type:	40-pin header (2x20)
CN Location:	See Figure 3-10
CN Pinouts:	See Table 3-10

The 40-pin serial port connector contains the following four serial ports: COM3, COM4, COM5 and COM6. All these serial ports are RS-232 serial communications channels. The serial port locations are specified below.

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- COM3 is located on pin 1 to pin 10
- COM4 is located on pin 11 to pin 20
- COM5 is located on pin 21 to pin 30
- COM6 is located on pin 31 to pin 40



Figure 3-10: COM3 to COM6 Connector Pinout Locations



PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	DATA CARRIER DETECT (DCD3)	2	DATA SET READY (DSR3)
3	RECEIVE DATA (RXD3)	4	REQUEST TO SEND (RTS3)
5	TRANSMIT DATA (TXD3)	6	CLEAR TO SEND (CTS3)
7	DATA TERMINAL READY (DTR3)	8	RING INDICATOR (RI3)
9	GND	10	GND
11	DATA CARRIER DETECT (DCD4)	12	DATA SET READY (DSR4)
13	RECEIVE DATA (RXD4)	14	REQUEST TO SEND (RTS4)
15	TRANSMIT DATA (TXD4)	16	CLEAR TO SEND (CTS4)
17	DATA TERMINAL READY (DTR4)	18	RING INDICATOR (RI4)
19	GND	20	GND
21	DATA CARRIER DETECT (DCD5)	22	DATA SET READY (DSR5)
23	RECEIVE DATA (RXD5)	24	REQUEST TO SEND (RTS5)
25	TRANSMIT DATA (TXD5)	26	CLEAR TO SEND (CTS5)
27	DATA TERMINAL READY (DTR5)	28	RING INDICATOR (RI5)
29	GND	30	GND
31	DATA CARRIER DETECT (DCD6	32	DATA SET READY (DSR6)
33	RECEIVE DATA (RXD6)	34	REQUEST TO SEND (RTS6)
35	TRANSMIT DATA (TXD6	36	CLEAR TO SEND (CTS6)
37	DATA TERMINAL READY (DTR6	38	RING INDICATOR (RI6)
39	GND	40	GND

Table 3-10: COM3 to COM6 Connector Pinouts

3.3.10 Serial Port Connector (COM 2)(RS-232, RS-422 or RS-485)

- CN Label: COM2
- **CN Type:** 14-pin header (2x7)
- CN Location: See Figure 3-11
- CN Pinouts: See Table 3-11

The 14-pin serial port connector connects to the COM2 serial communications channels. COM2 is a multi function channel. In default mode COM2 is an RS-232 serial

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communication channel but, with the COM2 function select jumper, can be configured as either an RS-422 or RS-485 serial communications channel.

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Figure 3-11: RS-232/422/485 Serial Port Connector Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	NDCD	2	NDSR2
3	NRX	4	NRTS2
5	NTX	6	NCTS2
7	NDTR	8	NRI2
9	GND	10	GND
11	TXD485+	12	TXD485-
13	RXD485+	14	RXD485-

Table 3-11: RS-232/RS-485 Serial Port Connector Pinouts

3.3.11 USB Connectors (Internal)

CN Label:	USB4
СN Туре:	8-pin header (2x4)
CN Location:	See Figure 3-12
CN Pinouts:	See Table 3-12

The 2x4 USB pin connectors each provide connectivity to two USB 1.1 or two USB 2.0 ports. Each USB connector can support two USB devices. Additional external USB ports are found on the rear panel. The USB ports are used for I/O bus expansion.



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Figure 3-12: USB Connector Pinout Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	VCC	2	GND
3	DATA-	4	DATA+
5	DATA+	6	DATA-
7	GND	8	VCC

Table 3-12: USB Port Connector Pinouts







Installation





4.1 Anti-static Precautions

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If the following anti-static precautions are not followed, a user may be injured and the system irreparably damaged.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the WAFER series motherboard and the power module. (Dry climates are especially susceptible to ESD.) It is therefore critical that whenever the ECW-281B/B2-D525 is opened and any electrical component handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- Self-grounding:- Before handling the board, touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.

4.2 Installation Procedure

4.2.1 Installation Procedure Overview

To properly install the ECW-281B/B2-D525, the following steps must be followed. Detailed descriptions of these instructions are listed in the sections that follow.

- Step 1: Unpacking
- Step 2: Configure the jumper settings
- Step 3: Install the SATA hard disk drive (HDD)
- Step 4: Mount the ECW-281B/B2-D525
- **Step 5:** Connect the front panel peripheral connectors

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Step 6: Power the system up

4.2.2 Unpacking

After the ECW-281B/B2-D525 is received make sure the following components are included in the package. If any of these components are missing, please contact the ECW-281B/B2-D525 reseller or vendor where it was purchased or contact an IEI sales representative immediately.

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Quantity	Item	Image
1	ECW-281B/B2-D525 embedded system	
2	Mounting brackets	
1	Screw set	
1	DIN mount kit	
1	SATA and power cable	
1	Thermal pad for HDD	
1	Quick installation guide	EEL Out handline can be wreak wreak of the second



1	Driver and manual CD	ili ili
1	Wireless antenna (wireless model only)	
1	Power cord	
	(optional for WD models)	
1	Power adapter with ERP and PSE	
	certificates (optional for WD models)	(A)
	(P/N: 63000-FSP060DBAB1552-RS)	
1	VESA MIS-D 100 wall mount kit	
	(optional)	

Table 4-1: Package List Contents

4.2.3 Bottom Surface Removal

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Over-tightening bottom cover screws will cause damage to the bottom surface. Maximum torque for cover screws is 5 kg-cm (0.36 lb-ft/0.49 Nm).

Before the jumper settings can be configured and the hard disk drive can be installed, the bottom surface must be removed. To remove the bottom surface, please follow the steps below:

Step 1: Remove the bottom surface retention screws. The bottom surface is secured to the chassis with six retention screws (Figure 4-1). All six screws must be removed.

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Figure 4-1: Bottom Surface Retention Screws

Step 2: Gently remove the bottom surface from the ECW-281B/B2-D525.

4.2.4 Configure the Jumper Settings

To configure the jumper settings, please follow the steps below.

- Step 1: Remove the bottom surface. See Section 4.2.3.
- Step 2: Locate the jumper settings on the embedded motherboard. See Chapter4.2.4.1.
- Step 3: Make the jumper settings in accordance with the settings described and defined in Chapter 4.2.4.1.



4.2.4.1 Jumpers

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A jumper is a metal bridge used to close an electrical circuit. It consists of two or three metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To CLOSE/SHORT a jumper means connecting the pins of the jumper with the plastic clip and to OPEN a jumper means removing the plastic clip from a jumper.





Figure 4-2: Jumpers

The WAFER-PV-D5252 motherboard has several onboard jumpers (Table 4-2).

Description	Label	Туре
Clear CMOS	J_CMOS1	3-pin header
CompactFlash® master/slave selection	JCF1	2-pin header
COM2 RS-232/422/485 selection	JP1	8-pin header
COM1 pin-9 voltage selection	JP2	6-pin header

Table 4-2: Jumpers

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4.2.4.2 CF Card Setup

Jumper Label:	JCF1	
Jumper Type:	2-pin header	
Jumper Settings:	See Table 4-3	
Jumper Location:	See Figure 4-3	

The CF Card Setup jumper sets the CF Type I card or CF Type II cards as either the slave device or the master device. CF Card Setup jumper settings are shown in Table 4-3.

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CF Card Setup	Description	
OFF	Slave	Default
Short 1-2	Master	

Table 4-3: CF Card Setup Jumper Settings

The CF Card Setup jumper location is shown in Figure 4-3.



Figure 4-3: CF Card Setup Jumper Location

4.2.4.3 Clear CMOS Jumper

Jumper Label:	J_CMOS1
Jumper Type:	3-pin header
Jumper Settings:	See Table 4-4
Jumper Location:	See Figure 4-4



If the ECW-281B/B2-D525 fails to boot due to improper BIOS settings, the clear CMOS jumper clears the CMOS data and resets the system BIOS information. To do this, use the jumper cap to close pins 2 and 3 for a few seconds then reinstall the jumper clip back to pins 1 and 2.

If the "CMOS Settings Wrong" message is displayed during the boot up process, the fault may be corrected by pressing the F1 to enter the CMOS Setup menu. Do one of the following:

- Enter the correct CMOS setting
- Load Optimal Defaults

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Load Failsafe Defaults.

After having done one of the above, save the changes and exit the CMOS Setup menu.

The clear CMOS jumper settings are shown in Table 4-4.

Clear CMOS	Description	
Short 1 - 2	Keep CMOS Setup	Default
Short 2 - 3	Clear CMOS Setup	

Table 4-4: Clear CMOS Jumper Settings

The location of the clear CMOS jumper is shown in Figure 4-4 below.



Figure 4-4: Clear CMOS Jumper

4.2.4.4 COM 6 Function Select Jumper (ECW-281B-D525 Series Only)

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Jumper Label:	JP1
Jumper Type:	8-pin header
Jumper Settings:	See Table 4-5
Jumper Location:	See Figure 4-5

The COM 6 Function Select jumper sets the communication protocol used by the second serial communications port (COM 6) as RS-232, RS-422 or RS-485. The COM 6 Function Select settings are shown in **Table 4-5**.

COM 6 Function Select	Description	
Short 1-2	RS-232	Default
Short 3-4	RS-422	
Short 5-6	RS-485	
Short 5-6	RS-485 with RTS control	
Short 7-8		

Table 4-5: COM 6 Function Select Jumper Settings

The COM 6 Function Select jumper location is shown in Figure 4-5.



Figure 4-5: COM 2 Function Select Jumper Location





4.2.4.5 COM 1 Pin 9 Setting Jumper

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Jumper Label:	JP2
Jumper Type:	6-pin header
Jumper Settings:	See Table 4-6
Jumper Location:	See Figure 4-6

The COM 1 Pin 9 Setting jumper configures pin 9 on COM 1 as either a +5 V, +12 V power source or as a ring-in (RI) line. The COM 1 Pin 9 Setting jumper selection options are shown in Table 4-6.

Setting	Description
Short 1-3	COM 1 RI Pin use +5 V
Short 3-5	COM 1 RI Pin use +12 V
Short 3-4	COM 1 RI Pin use RI (Default)

Table 4-6: COM 1 Pin 9 Setting Jumper Settings



Figure 4-6: COM 1 Pin 9 Setting Jumper Location



4.2.5 Hard Drive Installation

One 2.5" SATA hard drive supported. The SATA drive is installed into a hard drive bracket attached on the inside of the bottom panel (**Figure 4-7**).

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Figure 4-7: Hard Drive Bracket

To install the hard drive into the system, please follow the steps below.

- **Step 1:** Remove the bottom surface See Section 4.2.3.
- **Step 2:** Remove the hard drive bracket from the bottom surface by removing the four retention screws that secure the bracket to the bottom surface. (**Figure 4-8**)



Figure 4-8:HDD Bracket Retention Screws

Step 3: Place the HDD into the bracket.





- Step 4: Align the retention screw holes in the HDD with those in the bottom of the bracket.
- Step 5: Secure the HDD with the bracket by inserting four retention screws into the bottom of the bracket (Figure 4-9).



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Figure 4-9: HDD Retention Screws

- **Step 6:** Locate the breather hole of the HDD. Cut off the corresponding area of the breather hole from the thermal pad.
- Step 7: Adhere the thermal pad to the HDD. Make sure there is no obstacle covering the breather hole (Figure 4-10).



Make sure the breather hole of the HDD is not covered. Covering the breather hole may cause damage to the HDD.







Figure 4-10: HDD Thermal Pad

- **Step 8:** Replace the HDD bracket onto the bottom surface by aligning the four retention screw holes in the HDD bracket with those in the back of the bottom surface.
- Step 9: Reinsert the four previously removed retention screws.
- Step 10: Connect the SATA cable connector in the ECW-281B/B2-D525 to the HDD.
- **Step 11:** Replace the bottom surface to the bottom panel by reinserting the six previously removed retention screws.



Over-tightening bottom cover screws will cause damage to the bottom surface. Maximum torque for cover screws is 5 kg-cm (0.36 lb-ft/0.49 Nm).



4.2.6 Mounting the System with Mounting Brackets

To mount the embedded system onto a wall or some other surface using the two mounting brackets, please follow the steps below.

Step 1: Turn the embedded system over.

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- **Step 2:** Align the two retention screw holes in each bracket with the corresponding retention screw holes on the sides of the bottom surface.
- Step 3: Secure the brackets to the system by inserting two retention screws into each bracket.



Figure 4-11: Mounting Bracket Retention Screws

- **Step 4:** Drill holes in the intended installation surface.
- **Step 5:** Align the mounting holes in the sides of the mounting brackets with the predrilled holes in the mounting surface.
- Step 6: Insert four retention screws, two in each bracket, to secure the system to the wall.

4.2.7 Mounting the System with Wall Mount Kit

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To mount the embedded system onto a wall using the VESA MIS-D 100 wall mount kit, please follow the steps below.

Step 1: Select the location on the wall for the wall-mounting bracket.

- Step 2: Carefully mark the locations of the four bracket screw holes on the wall.
- Step 3: Drill four pilot holes at the marked locations on the wall for the bracket retention screws.

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- **Step 4:** Align the wall-mounting bracket screw holes with the pilot holes.
- Step 5: Secure the mounting-bracket to the wall by inserting the retention screws into the four pilot holes and tightening them (Figure 4-12).



Figure 4-12: Wall-mounting Bracket

- Step 6: Insert the four monitor mounting screws provided in the wall mounting kit into the four screw holes on the bottom panel of the system and tighten until the screw shank is secured against the bottom panel (760H760HFigure 4-13).
- Step 7: Align the mounting screws on the ECW-281B/B2-D525 bottom panel with the mounting holes on the bracket.
- Step 8: Carefully insert the screws through the holes and gently pull the monitor downwards until the ECW-281B/B2-D525 rests securely in the slotted holes (Figure 4-13). Ensure that all four of the mounting screws fit snuggly into their respective slotted holes.







In the diagram below the bracket is already installed on the wall.



Figure 4-13: Mount the Embedded System

4.2.8 DIN Mounting

To mount the ECW-281B/B2-D525 embedded system onto a DIN rail, please follow the steps below.



Step 1: Attach the DIN rail mounting bracket to the bottom panel of the embedded system. Secure the bracket to the embedded system with the supplied retention screws (Figure 4-14).

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Figure 4-14: DIN Rail Mounting Bracket

Step 2: Make sure the inserted screw in the center of the bracket is at the lowest

position of the elongated hole (Figure 4-15).



Figure 4-15: Screw Locations

Step 3: Place the DIN rail flush against the back of the mounting bracket making sure the edges of the rail are between the upper and lower clamps (Figure 4-16).







Figure 4-16: Mounting the DIN RAIL

Step 4: Secure the DIN rail to the mounting bracket by turning the top screw clockwise.This draws the lower clamp up and secures the embedded system to the DIN rail (Figure 4-17).



Figure 4-17: Secure the Assembly to the DIN Rail

4.2.9 Wireless Antenna Installation (Wireless Models Only)

To install an antenna to the wireless ECW-281B/B2-D525 series for efficient wireless network transmission, follow the steps below.

- **Step 1:** Locate the antenna connector on the rear panel of the embedded system (refer to **Figure 2-3**).
- Step 2: Install the antenna to the antenna connector (Figure 4-18).

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Figure 4-18: Wireless Antenna Installation

4.2.10 Cable Connections

Once the system has been mounted on the wall, the following connectors can be connected to the system.

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- VGA cable connector
- Serial port connectors
- RJ-45 connectors
- USB devices can be connected to the system.

The cable connection locations are shown in Figure 2-3.

4.3 Power-On Procedure

4.3.1 Installation Checklist



Make sure a power supply with the correct input voltage is being fed into the system. Incorrect voltages applied to the system may cause damage to the internal electronic components and may also cause injury to the user.

To power on the embedded system please make sure of the following:

The bottom surface panel is installed





- All peripheral devices (VGA monitor, serial communications devices etc.) are connected
- The power cables are plugged in
- The system is securely mounted

4.3.2 Terminal Block Pinouts

The terminal block pinouts are shown in Figure 4-19.



Figure 4-19: Terminal Block Pinouts

The chassis ground is connected to the ECW chassis internally. The cable ground is connected to the ground pin on the input power connector of the power module.

4.3.3 Power-on Procedure

To power-on the ECW-281B/B2-D525 please follow the steps below:

- Step 1: Push the power button.
- Step 2: Once turned on, the power button should turns to blue. See Figure 4-20.







Figure 4-20: Power Button







BIOS



5.1 Introduction

The BIOS is programmed onto the BIOS chip. The BIOS setup program allows changes to certain system settings. This chapter outlines the options that can be changed.

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5.1.1 Starting Setup

The UEFI BIOS is activated when the computer is turned on. The setup program can be activated in one of two ways.

- 1. Press the F2 key as soon as the system is turned on or
- Press the F2 key when the "Press F2 to enter SETUP" message appears on the screen.

If the message disappears before the **F2** key is pressed, restart the computer and try again.

5.1.2 Using Setup

Use the arrow keys to highlight items, press **ENTER** to select, use the PageUp and PageDown keys to change entries, press **F1** for help and press **Esc** to quit. Navigation keys are shown in.

Кеу	Function
Up arrow	Move to the item above
Down arrow	Move to the item below
Left arrow	Move to the item on the left hand side
Right arrow	Move to the item on the right hand side
+	Increase the numeric value or make changes
-	Decrease the numeric value or make changes
Page up	Move to the next page
Page down	Move to the previous page



Кеу	Function
Esc	Main Menu – Quit and do not save changes into CMOS
	Status Page Setup Menu and Option Page Setup Menu
	Exit current page and return to Main Menu
F1	General help, only for Status Page Setup Menu and Option
	Page Setup Menu
F9	Load optimized defaults
F10	Save changes and Exit BIOS

Table 5-1: BIOS Navigation Keys

5.1.3 Getting Help

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When **F1** is pressed a small help window describing the appropriate keys to use and the possible selections for the highlighted item appears. To exit the Help Window press **Esc** or the **F1** key again.

5.1.4 Unable to Reboot After Configuration Changes

If the computer cannot boot after changes to the system configuration is made, CMOS defaults. Use the jumper described in Chapter **4**.

5.1.5 BIOS Menu Bar

The menu bar on top of the BIOS screen has the following main items:

- Main Changes the basic system configuration.
- Advanced Changes the advanced system settings.
- Chipset Changes the chipset settings.
- Boot Changes the system boot configuration.
- Security Sets User and Supervisor Passwords.
- Save & Exit Selects exit options and loads default settings

The following sections completely describe the configuration options found in the menu items at the top of the BIOS screen and listed above.

5.2 Main

The **Main** BIOS menu (**BIOS Menu 1**) appears when the **BIOS Setup** program is entered. The **Main** menu gives an overview of the basic system information.

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Aptio Setup Utility - Copyright (C) 2010 American Megatrends, Inc.			
Main Advanced	Chipset Boot Secur	ity Save	& Exit
BIOS Information BIOS Vendor Core Version Compliency Project Version Build Date	American Meg 4.6.4.0 0.20 UEFI 2.0 E338AR14.ROM 09/03/2010 1	atrends 5:39:09	Set the Time. Use Tab to switch between Time elements.
System Date System Time	[Tue 05/06/2 [14:20:27]	008]	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help</pre>
Access Level	Administrato	c	F2 Previous ValuesF3 Optimized DefaultsF4 SaveESC Exit
Version 2.02.	1205. Copyright (C) 2010	American	Megatrends, Inc.

BIOS Menu 1: Main

➔ BIOS Information

The **BIOS Information** lists a brief summary of the BIOS. The fields in **BIOS Information** cannot be changed. The items shown in the system overview include:

- BIOS Vendor: Installed BIOS vendor
- Core Version: Current BIOS version
- Project Version: the board version
- Build Date: Date the current BIOS version was made

The System Overview field also has two user configurable fields:

→ System Date [xx/xx/xx]

Use the **System Date** option to set the system date. Manually enter the day, month and year.





➔ System Time [xx:xx:xx]

Use the **System Time** option to set the system time. Manually enter the hours, minutes and seconds.

5.3 Advanced

Use the **Advanced** menu (**BIOS Menu 2**) to configure the CPU and peripheral devices through the following sub-menus:



Setting the wrong values in the sections below may cause the system to malfunction. Make sure that the settings made are compatible with the hardware.

Aptio Setup Utility - Copyright (C) 2010 Americ	an Megatrends, Inc.
Main Advanced Chipset Boot Security Sav	e & Exit
<pre>> ACPI Settings > CPU Configuration > IDE Configuration</pre>	System ACPI Parameters
> USB Configuration> Super IO Configuration> H/M Monitor	
> Serial Port Console Redirection > IEI Feature	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults E4</pre>
	F4 Save ESC Exit
Version 2.02.1205. Copyright (C) 2010 Americar	h Megatrends, Inc.

BIOS Menu 2: Advanced

5.3.1 ACPI Configuration

The **ACPI Configuration** menu (**BIOS Menu 3**) configures the Advanced Configuration and Power Interface (ACPI) options.



Aptio Setup Utility	- Copyright (C) 2010 America	an Megatrends, Inc.
Advanced		
ACPI Sleep State	[S1 (CPU Stop Clock)]	Select the highest ACPI sleep state the system will enter, when the SUSPEND button is pressed.
		<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save ESC Exit</pre>
Version 2.02.1205.	Copyright (C) 2010 American	Megatrends, Inc.

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BIOS Menu 3: ACPI Configuration

→ ACPI Sleep State [S1 (CPU Stop Clock)]

Use the **ACPI Sleep State** option to specify the sleep state the system enters when it is not being used.

→	S1	(CPU	Stop	DEFAULT	The system enters S1(POS) sleep state. The
	Cloc	ck)			system appears off. The CPU is stopped; RAM is
					refreshed; the system is running in a low power
					mode.
→	S 3	(Susper	nd to		The caches are flushed and the CPU is powered
	RAN	/)			off. Power to the RAM is maintained. The
					computer returns slower to a working state, but
					more power is saved.





5.3.2 CPU Configuration

Use the **CPU Configuration** menu (**BIOS Menu 4**) to view detailed CPU specifications and configure the CPU.

Aptio Setup Utility Advanced	- Copyright (C) 2010 America	n Megatrends, Inc.
CPU Configuration		
Processor Type	Intel(R) Atom(TM) CPU D525 @1.80GHz	
EMT64	Supported	
Processor Speed	1800 MHz	
System Bus Speed	800 MHz	
Ratio Status	9	\leftrightarrow : Select Screen
Actual Ratio	9	$\uparrow \downarrow$: Select Item
Processor Stepping	106ca	EnterSelect
Microcode Revision	263	F1 General Help
L1 Cache RAM	2x56 k	F2 Previous Values
L2 Cache RAM	2x512 k	F3 Optimized
Processor Cores	Dual	Defaults
Hyper-Threading	Supported	F4 Save
		ESC Exit
Hyper-Threading	[Enabled]	
Version 2 02 1205	Copyright (C) 2010 American	Megatrends. Inc

BIOS Menu 4: CPU Configuration

The CPU Configuration menu (BIOS Menu 4) lists the following CPU details:

- Processor Type: Lists the brand name of the CPU being used
- EMT64: Indicates if the EM64T is supported by the CPU.
- Processor Speed: Lists the CPU processing speed
- Actual Ratio: Lists the ratio of the frequency to the clock speed
- Processor Stepping: Lists the CPU processing stepping
- Microcode Revision: Lists the microcode revision
- L1 Cache RAM: Lists the CPU L1 cache size
- L2 Cache RAM: Lists the CPU L2 cache size
- Processor Cores: Lists the number of the processor core
- Hyper-Threading: Indicates if the Intel HT Technology is supported by the CPU.

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→ Hyper Threading [Enabled]

Use the Hyper Threading function to enable or disable the CPU hyper threading function.

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→	Disabled		Disables the use of hyper threading technology
→	Enabled	DEFAULT	Enables the use of hyper threading technology

5.3.3 IDE Configuration

Use the **IDE Configuration** menu (**BIOS Menu 5**) to change and/or set the configuration of the IDE devices installed in the system.

Aptio Setup Utility	- Copyright (C) 2010 Americ	an Megatrends, Inc.
Advanced		
SATA Configuration		Select ATA/IDE Configuration.
SATA Port0	Not Present	
SATA Port1	Not Present	
SATA Port2	Not Present	
SATA Port3	Not Present	
ATA/IDE Configuration Configure SATA as	[Enhanced] [IDE]	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save ESC Exit</pre>
Version 2.02.1205.	Copyright (C) 2010 Americar	Megatrends, Inc.

BIOS Menu 5: IDE Configuration

→ ATA/IDE Configurations [Enhanced]

Use the ATA/IDE Configurations option to configure the ATA/IDE controller.

- **Disabled** Disables the on-board ATA/IDE controller.
- Compatible Configures the on-board ATA/IDE controller to be in compatible mode. In this mode, a SATA channel will replace one of the IDE channels. This mode supports up to 4 storage devices.





Enhanced DEFAULT Configures the on-board ATA/IDE controller to be in Enhanced mode. In this mode, IDE channels and SATA channels are separated. This mode supports up to 6 storage devices. Some legacy OS do not support this mode.

→ Configure SATA as [IDE]

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Use the **Configure SATA as** option to configure SATA devices as normal IDE devices.

→	IDE	DEFAULT	Configures SATA devices as normal IDE device.
→	AHCI		Configures SATA devices as normal AHCI device.

5.3.4 USB Configuration

Use the **USB Configuration** menu (**BIOS Menu 6**) to read USB configuration information and configure the USB settings.

Aptio Setup Utility - Copy Advanced	right (C) 2010 America	n Megatrends, Inc.
USB Configuration		Enables Legacy USB support. AUTO option
USB Devices: 1 Keyboard, 2 Hubs		disables legacy support if no USB devices are connected. DISABLE
Legacy USB Support	[Enabled]	option will keep USB devices available only for EFI applications.
		←→: Select Screen
		<pre>↑↓: Select Item EnterSelect</pre>
		F1 General Help F2 Previous Values
		F3 Optimized Defaults
Version 2 02 1205 Conve	acht (C) 2010 Amorian	F4 Save ESC Exit
Version 2.02.1205. Copyri	ight (C) 2010 American	Megatrends, Inc.

BIOS Menu 6: USB Configuration

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➔ USB Devices

The USB Devices Enabled field lists the USB devices that are enabled on the system

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→ Legacy USB Support [Enabled]

Use the **Legacy USB Support** BIOS option to enable USB mouse and USB keyboard support. Normally if this option is not enabled, any attached USB mouse or USB keyboard does not become available until a USB compatible operating system is fully booted with all USB drivers loaded. When this option is enabled, any attached USB mouse or USB keyboard can control the system even when there is no USB driver loaded onto the system.

→	Enabled	DEFAULT	Legacy USB support enabled
→	Disabled		Legacy USB support disabled
→	Auto		Legacy USB support disabled if no USB devices are
			connected

5.3.5 Super IO Configuration

Use the **Super IO Configuration** menu (**BIOS Menu 7**) to set or change the configurations for the FDD controllers, parallel ports and serial ports.

Aptio Setup Utility - Copyright (C) 2010 America	n Megatrends, Inc.
Advanced	
Super IO Configuration	Set Parameters of Serial Port 0 (COMA)
Super IO Chip Finteck F81865	
<pre>> Serial Port 1 Configuration > Serial Port 3 Configuration > Serial Port 4 Configuration > Serial Port 5 Configuration > Serial Port 6 Configuration > Serial Port 2 Configuration</pre>	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save ESC Exit</pre>
Version 2.02.1205. Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 7: Super IO Configuration




5.3.5.1 Serial Port n Configuration

Use the Serial Port n Configuration menu (BIOS Menu 8) to configure the serial port n.

Aptio Setup Utility - Copy Advanced	right (C) 2010 America	n Megatrends, Inc.
Serial Port 1 Configuration		Enable or Disable Serial Port (COM)
Serial Port	[Enabled]	
Device Settings	IO=3F8h; IRQ=4	
5	~	
Change Settings	[Auto]	←→: Select Screen
		$\uparrow \downarrow$: Select Item
		EnterSelect
		F1 General Help
		F2 Previous Values
		F3 Optimized
		Defaults
		F4 Save
		ESC Exit
Version 2.01.1204. Copyr	ight (C) 2010 American	Megatrends, Inc.

BIOS Menu 8: Serial Port n Configuration Menu

5.3.5.1.1 Serial Port 1 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

→	Disabled	Disable the serial port
---	----------	-------------------------

Enabled DEFAULT Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address
			are automatically detected.
→	IO=3F8h;		Serial Port I/O port address is 3F8h and the interrupt
	IRQ=4		address is IRQ4

→	IO=3F8h;	Serial Port I/O port address is 3E8h and the interrupt
	IRQ=3, 4	address is IRQ3, 4
→	IO=2F8h;	Serial Port I/O port address is 2F8h and the interrupt
	IRQ=3, 4	address is IRQ3, 4

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5.3.5.1.2 Serial Port 3 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

→	Disabled		Disable the serial port
→	Enabled	DEFAULT	Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=2F8h; IRQ=3		Serial Port I/O port address is 2F8h and the interrupt address is IRQ3
→	IO=3F8h; IRQ=3, 4		Serial Port I/O port address is 3F8h and the interrupt address is IRQ3, 4
→	IO=2F8h; IRQ=3, 4		Serial Port I/O port address is 2F8h and the interrupt address is IRQ3, 4

5.3.5.1.3 Serial Port 4 Configuration

→ Serial Port [Enabled]

Disabled

Use the Serial Port option to enable or disable the serial port.



Disable the serial port



Enabled DEFAULT Enable the serial port

→ Change Settings [Auto]

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Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=3E8h; IRQ=11		Serial Port I/O port address is 3E8h and the interrupt address is IRQ11
→	IO=3E8h; IRQ=10, 11		Serial Port I/O port address is 3E8h and the interrupt address is IRQ10, 11
→	IO=2E8h; IRQ=10, 11		Serial Port I/O port address is 2E8h and the interrupt address is IRQ10, 11

5.3.5.1.4 Serial Port 5 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

- Disabled
 Disable the serial port
- Enabled DEFAULT Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

Auto DEFAULT The serial port IO port address and interrupt address are automatically detected.

→	IO=2E8h;	Serial Port I/O port address is 2E8h and the interrupt
	IRQ=10	address is IRQ10
→	IO=3E8h; IRQ=10, 11	Serial Port I/O port address is 3E8h and the interrupt address is IRQ10, 11
→	IO=2E8h; IRQ=10, 11	Serial Port I/O port address is 2E8h and the interrupt address is IRQ10, 11

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5.3.5.1.5 Serial Port 6 Configuration

→ Serial Port [Enabled]

Use the Serial Port option to enable or disable the serial port.

→	Disabled		Disable the serial port
→	Enabled	DEFAULT	Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address are automatically detected.
→	IO=2C0h; IRQ=11		Serial Port I/O port address is 2C0h and the interrupt address is IRQ11
→	IO=2C0h; IRQ=10, 11		Serial Port I/O port address is 2C0h and the interrupt address is IRQ10, 11
→	IO=2C8h; IRQ=10, 11		Serial Port I/O port address is 2C8h and the interrupt address is IRQ10, 11





5.3.5.1.6 Serial Port 2 Configuration

→ Serial Port [Enabled]

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Use the Serial Port option to enable or disable the serial port.

→	Disabled		Disable the serial port
→	Enabled	DEFAULT	Enable the serial port

→ Change Settings [Auto]

Use the **Change Settings** option to change the serial port IO port address and interrupt address.

→	Auto	DEFAULT	The serial port IO port address and interrupt address
			are automatically detected.
→	IO=2C8h;		Serial Port I/O port address is 2C8h and the interrupt
	IRQ=10		address is IRQ10
→	IO=2C0h;		Serial Port I/O port address is 2C0h and the interrupt
	IRQ=10, 11		address is IRQ10, 11
→			
	10=2C8n;		Serial Port I/O port address is 208h and the interrupt
	IRQ=10, 11		address is IRQ10, 11

5.3.6 H/W Monitor

The H/W Monitor menu (**BIOS Menu 9**) shows the operating temperature, fan speeds and system voltages.

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Aptio Setup Utility -	- Copyright (C) 2010 American	Megatrends, Inc.
Advanced		
Aptio Setup Utility - Advanced PC Health Status CPU Temperature Accuracy:1.(-5~+10)degree a 2.(-10~+15)degree SYS Temperature CPU FAN Speed SYS FAN Speed VCC3C V_core V1_05V VCC3V Vcc VSB3V	- Copyright (C) 2010 American :+53 C around 100 degree around 50 degree :+37 C :N/A :N/A :+3.312 V :+1.160 V :+1.040 V :+3.288 V :+5.003 V :+3.328 V	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized</pre>
VBAT CPU Smart Fan control Temperature Bound 1 Temperature Bound 2 Temperature Bound 3 Temperature Bound 4 SYS Smart Fan control Temperature Bound 1 Temperature Bound 2 Temperature Bound 3 Temperature Bound 4	:+3.216 V [Auto Mode] 60 50 40 30 [Auto Mode] 60 50 40 30	Defaults F4 Save ESC Exit



→ PC Health Status

The following system parameters and values are shown. The system parameters that are monitored are:

- System Temperatures:
 - O CPU Temperature
 - O System Temperature
- Fan Speeds:





- O CPU Fan Speed
- O System Fan Speed
- Voltages:
 - O VCC3V
 - O V_core
 - O V1_05V
 - O VCC3V
 - O Vcc
 - O VSB3V
 - O VBAT

→ CPU Smart Fan control [Auto Mode]

Use the CPU Smart Fan control option to configure the CPU fan.

→	Auto Mode	The fan adjusts its speed using these settings:				
		Temperature Bound 1				
		Temperature Bound 2				
		Temperature Bound 3				
		Temperature Bound 4				
→	Manual Mode	The fan spins at the speed set in:				
		Manual Duty Cycle Setting				

5.3.7 Serial Port Console Redirection

The **Serial Port Console Redirection** menu (**BIOS Menu 10**) allows the console redirection options to be configured. Console redirection allows users to maintain a system remotely by re-directing keyboard input and text output through the serial port.



Aptio Setup Utility - Copy Advanced	right (C) 2010 America	n Megatrends, Inc.
COM1 Console Redirection > Console Redirection Settings	[Disabled]	Console Redirection Enable/Disable
COM3 Console Redirection > Console Redirection Settings	[Disabled]	
COM4 Console Redirection > Console Redirection Settings	[Disabled]	
COM5 Console Redirection > Console Redirection Settings	[Disabled]	<pre>↑↓: Select Item EnterSelect F1 General Help E2 Durations Values</pre>
COM6 Console Redirection > Console Redirection Settings	[Disabled]	F2 Previous values F3 Optimized Defaults F4 Save
COM2 Console Redirection > Console Redirection Settings	[Disabled]	ESC Exit
Version 2.02.1205. Copyr	ight (C) 2010 American	Megatrends, Inc.

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BIOS Menu 10: Serial Port Console Redirection

→ Console Redirection [Disabled]

Use **Console Redirection** option to enable or disable the console redirection function.

Disabled DEFAULT Disabled the console redirection function
 Enabled Enabled the console redirection function

→ Terminal Type [ANSI]

Use the **Terminal Type** option to specify the remote terminal type.

→	VT100		The target terminal type is VT100
→	VT100+		The target terminal type is VT100-
→	ANSI	DEFAULT	The target terminal type is ANSI





→ Bits per second [115200]

Use the **Bits per second** option to specify the bits per second.

- 9600
- 19200
- 57600
- 115200 **DEFAULT**

5.3.8 IEI Feature

Use the IEI Feature menu (BIOS Menu 11) to configure One Key Recovery function.

			BIOS SETU	P UTILITY		
Main	Advanced	PCIPNP	Boot	Security	Chipset	Exit
iEi Featu	re					
Auto Reco	very Funct	ion	[Disab]	.ed]		
					←→	Select Screen
					∣ ↓ Enter	Go to SubScreen
					F1	General Help
					F10	Save and Exit
					ESC	Exit
	v02.61 (OCopyright	1985-2006	, American	Megatrends	, Inc.

BIOS Menu 11: IEI Feature

→ Auto Recovery Function [Disabled]

Use the **Auto Recovery Function** BIOS option to enable or disable the auto recovery function of the IEI One Key Recovery.

→	Disabled	DEFAULT	Auto recovery function disabled
→	Enabled		Auto recovery function enabled



5.4 Chipset

Use the **Chipset** menu (**BIOS Menu 12**) to access the Northbridge and Southbridge configuration menus

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Setting the wrong values for the Chipset BIOS selections in the Chipset BIOS menu may cause the system to malfunction.

Aptio Setup Utility - Copyright (C) 2010 America: Main Advanced Chipset Boot Security Save	n Megatrends, Inc. & Exit
> Host Bridge > South Bridge > Intel IGD SWSCI OpRegion	Host Bridge Parameters
	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save ESC Exit</pre>
Version 2.02.1205. Copyright (C) 2010 American	Megatrends, Inc.

BIOS Menu 12: Chipset





5.4.1 Host Bridge

Use the Host Bridge menu (BIOS Menu 13) to configure the host bridge chipset.

Aptio Setup Utility - Copy Chipset	yright (C) 2010 America	n Megatrends, Inc.
> OnChip VGA Configuration Initiate Graphic Adapter	[IGD]	Config On Chip VGA Settings
****** Memory Information ****	* * * *	
Memory Frequency	800 Mhz	
Total Memory	2048 MB	←→: Select Screen
DIMM#0 DIMM#1	2048 MB Not present	T↓: Select Item EnterSelect F1 General Help
		F2 Previous Values F3 Optimized
		Defaults F4 Save
		ESC Exit
Version 2.02.1205. Copyr	ight (C) 2010 American	Megatrends, Inc.

BIOS Menu 13:Host Bridge Configuration

→ Initiate Graphic Adapter

Use the **Initiate Graphic Adapter** option to select the graphics controller used as the primary boot device. Select either an integrated graphics controller (IGD) or a combination of PCI graphics controller, a PCI express (PEG) controller or an IGD. Configuration options are listed below:

- IGD
- PCI/IGD DEFAULT



5.4.1.1 OnChip VGA Configuration

Use the **OnChip VGA Configuration** menu (**BIOS Menu 13**) to configure the OnChip VGA.

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Aptio Setup Utility - (Chipset	Copyright (C) 201	0 American Megatrends, Inc.
OnChip VGA Configuration		Select Share Memory Size.
Share Memory Size	[8 MB]	
Multi-Monitor Support	[Enabled]	
		←→: Select Screen
		↑↓: Select Item
		EnterSelect
		F1 General Help
		F2 Previous Values
		F3 Optimized
		Defaults
		F4 Save
Version 2 01 1204 Cc	pright (C) 2010	ESC Exit

BIOS Menu 14: OnChip VGA Configuration

→ Share Memory Size [8 MB]

Use the **Share Memory Size** option to set the amount of system memory allocated to the integrated graphics processor when the system boots. The system memory allocated can then only be used as graphics memory, and is no longer available to applications or the operating system. Configuration options are listed below:

- Disabled
- 1 MB
- 8 MB Default

→ Multi-Monitor Support [Enabled]

Use **Multi-Monitor Support** option to enable or disable the multi-monitor function.





Disabled Disabled the multi-monitor function
 Enabled DEFAULT Enabled the multi-monitor function

5.4.2 South Bridge

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Use the South Bridge menu (BIOS Menu 15) to configure the Southbridge chipset.

Aptio Setup Utility - C Chipset	opyright (C) 2010 Americ	an Megatrends, Inc.
Auto Power Button Function Restore AC Power Loss HD Audio Controller USB Function USB 2.0(EHCI) Support	[Enabled] [Last State] [Enabled] [Enabled] [Enabled]	Enable/Disable Azalia HD Audio
Set Spread Spectrum function	[Disabled]	<pre>←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save ESC Exit</pre>
Version 2.02.1205. Cop	oyright (C) 2010 American	n Megatrends, Inc.

BIOS Menu 15:Southbridge Chipset Configuration

→ Restore on AC Power Loss [Last State]

Use the **Restore on AC Power Loss** BIOS option to specify what state the system returns to if there is a sudden loss of power to the system.

→	Power Off		The system remains turned off
→	Power On		The system turns on
→	Last State	DEFAULT	The system returns to its previous state. If it was on, it
			turns itself on. If it was off, it remains off.

→ HD Audio Controller [Enabled]

The HD Audio Controller option enables or disables the HD audio controller.

→	Enabled	DEFAULT	The	onboard	HD	audio	controller	automatically
			deteo	cted and er	nabled	ł		
→	Disabled		The o	onboard HI) aud	io contro	oller is disab	bled

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→ USB Function [Enabled]

Use the **USB Function** BIOS option to enable or disable USB function support.

→	Disabled	USB function support disabled

Enabled DEFAULT USB function support enabled

→ USB 2.0 (EHCI) Support [Enabled]

Use the USB 2.0 (EHCI) Support BIOS option to enable or disable the USB 2.0 controller.

→	Enabled	DEFAULT	USB 2.0 controller enabled
→	Disabled		USB 2.0 controller disabled

→ Set Spread Spectrum Function [Disabled]

The Set Spread Spectrum Function option can help to improve CPU EMI issues.

- Disabled DEFAULT The spread spectrum function is disabled
- Enabled
 The spread spectrum function is enabled

5.4.3 Intel IGD SWSCI OpRegion

Use the **Intel IGD SWSCI OpRegion** menu to configure the video device connected to the system.



Aptio Setup Utility - Copy	right (C) 2010 America	n Megatrends, Inc.
Advanced		
Intel IGD SWSCI OpRegion Configu DVMT Mode Select DVMT/Fixed Memory IGD - Boot Type LCD Panel Type Panel ID Resolution	Uration [DVMT Mode] [256 MB] [VBIOS Default] [Select by Panel ID] 800x600 18bit	Select DVMT/FIXED Mode ←→: Select Screen ↑↓: Select Item EnterSelect F1 General Help F2 Previous Values F3 Optimized Defaults F4 Save
		ESC Exit
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BIOS Menu 16: Intel IGD SWSCI OpRegion

➔ DVMT Mode Select [DVMT Mode]

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Use the **DVMT Mode Select** option to select the Intel Dynamic Video Memory Technology (DVMT) operating mode.

→	Fixed Mode		A fixed portion of graphics memory is reserved as graphics memory.
→	DVMT Mode	DEFAULT	Graphics memory is dynamically allocated according to the system and graphics needs.

→ DVMT/FIXED Memory [256 MB]

Use the **DVMT/FIXED Memory** option to specify the maximum amount of memory that can be allocated as graphics memory. Configuration options are listed below.

- 128 MB
- 256 MB **Default**
- Maximum

→ IGD - Boot Type [VBIOS Default]

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Use the **IGD** - **Boot Type** option to select the display device used by the system when it boots. Configuration options are listed below.

- VBIOS Default
 DEFAULT
- CRT
- LFP
- CRT + LFP

→ LCD Panel Type [VBIOS Default]

Use the **LCD Panel Type** option to select the type of flat panel connected to the system. Configuration options are listed below.

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- Select by Panel ID DEFAULT
- 640x480 18bit
- 800x480 18bit
- 800x600 18bit
- 1024x768 18bit
- 1280x1024 18bit
- 1366x768 18bit
- 1280x800 18bit
- 1280x600 18bit

5.5 Boot

Use the Boot menu (BIOS Menu 17) to configure system boot options.



BIOS Menu 17: Boot



➔ Bootup NumLock State [On]

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Use the **Bootup NumLock State** BIOS option to specify if the number lock setting must be modified during boot up.

- ➤ On DEFAULT Allows the Number Lock on the keyboard to be enabled automatically when the computer system boots up. This allows the immediate use of the 10-key numeric keypad located on the right side of the keyboard. To confirm this, the Number Lock LED light on the keyboard is lit.
- ➔ Off Does not enable the keyboard Number Lock automatically. To use the 10-keys on the keyboard, press the Number Lock key located on the upper left-hand corner of the 10-key pad. The Number Lock LED on the keyboard lights up when the Number Lock is engaged.

→ Quiet Boot [Enabled]

Use the **Quiet Boot** BIOS option to select the screen display when the system boots.

→	Disabled		Normal POST messages displayed
→	Enabled	DEFAULT	OEM Logo displayed instead of POST messages

→ Launch PXE OpROM [Disabled]

Use the **Launch PXE OpROM** option to enable or disable boot option for legacy network devices.

→	Disabled	DEFAULT	Ignore all PXE Option ROMs
-			



5.6 Security

Use the Security menu (BIOS Menu 18) to set system and user passwords.

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Aptio Setup Utility - Copyright (C) 2010 American Megatrends, Inc.						
Main Ao	dvanced	Chipset	Boot	Security	Save	e & Exit
Password De	scription	L				Set Setup Administrator Password
If ONLY the	Administ	rator's pa	ssword is	s set,		
then this or	nly limit	s access t	o Setup a	and is		
only asked :	for when	entering S	etup			
If ONLY the	User's p	assword is	set, the	en this		\leftrightarrow : Select Screen
is a power of	on passwo	rd and mus	t be ente	ered to		$\uparrow \downarrow$: Select Item
boot or ente	er Setup.	In Setup	the User	will		EnterSelect
have Administrator rights.				F1 General Help		
						F2 Previous Values
Administrat	or Passwo	rd				F3 Optimized
User Passwo:	rd					Defaults
						F4 Save
Set User Pa	ssword					ESC Exit
Set Master	Password					
Verg	ion 2 02	1205 Conv	riaht (C	') 2010 Amei	rican	Megatrends Inc

BIOS Menu 18: Security

➔ Administrator Password

Use the Administrator Password to set or change a administrator password.

➔ User Password

Use the User Password to set or change a user password.

5.7 Exit

Use the **Exit** menu (**BIOS Menu 19**) to load default BIOS values, optimal failsafe values and to save configuration changes.



Aptio Setu	p Utility - Co	pvriaht (C) 2010 Am	ericar	Megatrends, Inc.
Main Advanc	ed Chipset	Boot	Security	Save	& Exit
			1	1	
Save Changes an	nd Reset				Exit system setup after
Discard Changes	and Reset				saving the changes.
Diboara change.					Saving ene changes.
Restore Default	s				
Save as User De	faults				
Restore User De	efaults				
					←→: Select Screen
					↑↓: Select Item
					EnterSelect
					Fl General Help
					F2 Previous Values
					F3 Optimized
					Defaults
					F4 Save
					ESC Exit
Version 2	.01.1204. Copy	vright <u>(C)</u>	2010 Amer	cican 1	Megatrends, Inc.

BIOS Menu 19:Exit

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→ Save Changes and Reset

Use the **Save Changes and Reset** option to save the changes made to the BIOS options and to exit the BIOS configuration setup program.

→ Discard Changes and Reset

Use the **Discard Changes and Reset** option to exit the system without saving the changes made to the BIOS configuration setup program.

→ Restore Defaults

Use the **Restore Defaults** option to load the optimal default values for each of the parameters on the Setup menus. **F3 key can be used for this operation.**

→ Save as User Defaults

Use the Save as User Defaults option to save the changes done so far as user defaults.

➔ Restore User Defaults

Use the **Restore User Defaults** option to restore the user defaults to all the setup options.





Troubleshooting and Maintenance







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Take Anti-Static precautions whenever maintenance is being carried out on the system components. Failure to take anti-static precautions can cause permanent system damage. For more details on anti-static precautions, please refer to **Section 4.1**.

6.1 ECW-281B/B2-D525 System Maintenance Overview



When doing maintenance operations on the system, please follow the instructions in this chapter. Failure to follow these instructions may lead to personal injury and system damage.

To preserve the working integrity of the ECW-281B/B2-D525 embedded system, the system must be properly maintained. If embedded system components need replacement, the proper maintenance procedures must be followed to ensure the system can continue to operate normally.

6.2 System Troubleshooting

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This section provides some simple troubleshooting suggestions.

6.2.1 The System Doesn't Turn On

If after turning the system on, there is no power (indicated by the power button on the front panel not turning on) please do the following:

- **Step 1:** Check that the power cable connector is properly connected to the terminal block or power socket on the system front panel.
- **Step 2:** Check that the power cable connector is properly plugged into the power source.
- Step 3: Make sure the power button is turned on.

Step 4: Plug the system into a monitor and check to see if anything appears on the screen. If the boot-up screen appears it means the power LED has become disconnected. To fix this problem, open the top cover and reconnect the power LED to the motherboard.

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If the above steps have been completed and the system still doesn't turn on, please do the following.

- Step 1: Open the bottom surface (Section 4.2.3)
- **Step 2:** Check the terminal block/power socket power cable connector is properly connected to the power module or motherboard.
- Step 3: Check that the power button cable connector is properly connected to the motherboard.
- **Step 4:** Make sure the cable connecting to the terminal block/power socket are properly attached and have not become separated.
- **Step 5:** Make sure the cable connecting the power button to the motherboard is still properly attached to the power button and has not been separated.

6.2.2 The System Doesn't Boot Up

If the system doesn't boot up please do the following:

- Step 1: Check the power is turned on. See Section 6.2.1 above.
- **Step 2:** Make sure the SO-DIMM module is properly installed.
- Step 3: Reset the system using the reset CMOS jumper.





6.2.3 More Troubleshooting

Nothing appears on the monitor after booting up the system: Make sure the monitor is properly connected to the system and the monitor is connected to a power supply and turned on.

If all troubleshooting measures have been taken and the system still fails to start, contact the IEI reseller or vendor you purchased the ECW-281B/B2-D525 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to <u>sales@iei.com.tw</u>.

6.3 Component Replacement Procedure



Users are not advised to attempt to repair or replace any internal or external components of the ECW-281B/B2-D525 embedded system other than those listed below. If any other components fail or need replacement, contact the IEI reseller or vendor you purchased the ECW-281B/B2-D525 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to <u>sales@iei.com.tw</u>.

The embedded system components listed below can all be replaced if they fail:

- SO-DIMM module
- Internal hard disk drive (see Section 4.2.5)

6.3.1 SO-DIMM Replacement



Using incorrectly specified SO-DIMM may cause permanently damage the ECW-281B/B2-D525. Please make sure the purchased SO-DIMM complies with the memory specifications of the ECW-281B/B2-D525.

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To replace a SO-DIMM memory module into a SO-DIMM socket, please follow the steps below.

- Step 1: Remove the bottom surface panel. Place the ECW-281B/B2-D525 on an anti-static pad with the bottom panel facing up and the bottom surface removed. (see Section 4.2.3).
- Step 2: Locate the SO-DIMM on the motherboard.
- Step 3: Remove the SO-DIMM by releasing the arms on the SO-DIMM socket.
- Step 4: Align the new SO-DIMM with the socket. The SO-DIMM must be oriented in such a way that the notch in the middle of the SO-DIMM must be aligned with the plastic bridge in the socket (Figure 6-1).
- Step 5: Insert the SO-DIMM. Push the SO-DIMM chip into the socket at an angle (Figure 6-1).



Figure 6-1: SO-DIMM Installation



Step 6: Open the SO-DIMM socket arms. Gently pull the arms of the SO-DIMM socket out and push the rear of the SO-DIMM down. (See Figure 6-1)

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Step 7: Secure the SO-DIMM. Release the arms on the SO-DIMM socket. They clip into place and secure the SO-DIMM in the socket.







Safety Precautions







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The precautions outlined in this chapter should be strictly followed. Failure to follow these precautions may result in permanent damage to the ECW-281B/B2-D525.

A.1 Safety Precautions

Please follow the safety precautions outlined in the sections that follow:

A.1.1 General Safety Precautions

Please ensure the following safety precautions are adhered to at all times.

- Follow the electrostatic precautions outlined below whenever the ECW-281B/B2-D525 is opened.
- Make sure the power is turned off and the power cord is disconnected whenever the ECW-281B/B2-D525 is being installed, moved or modified.
- Do not apply voltage levels that exceed the specified voltage range.
 Doing so may cause fire and/or an electrical shock.
- Electric shocks can occur if the ECW-281B/B2-D525 chassis is opened when the ECW-281B/B2-D525 is running.
- Do not drop or insert any objects into the ventilation openings of the ECW-281B/B2-D525.
- If considerable amounts of dust, water, or fluids enter the ECW-281B/B2-D525, turn off the power supply immediately, unplug the power cord, and contact the ECW-281B/B2-D525 vendor.
- DO NOT:
 - O Drop the ECW-281B/B2-D525 against a hard surface.
 - O In a site where the ambient temperature exceeds the rated temperature

A.1.2 Anti-static Precautions



Failure to take ESD precautions during the installation of the ECW-281B/B2-D525 may result in permanent damage to the ECW-281B/B2-D525 and severe injury to the user.

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Electrostatic discharge (ESD) can cause serious damage to electronic components, including the ECW-281B/B2-D525. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the ECW-281B/B2-D525 is opened and any of the electrical components are handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging any electrical component.
- Self-grounding: Before handling any electrical component, touch any grounded conducting material. During the time the electrical component is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring or working with an electrical component, place it on an antic-static pad. This reduces the possibility of ESD damage.
- Only handle the edges of the electrical component: When handling the electrical component, hold the electrical component by its edges.





A.1.3 Product Disposal



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Risk of explosion if battery is replaced by and incorrect type. Only certified engineers should replace the on-board battery.

Dispose of used batteries according to instructions and local regulations.

- Outside the European Union If you wish to dispose of used electrical and electronic products outside the European Union, please contact your local authority so as to comply with the correct disposal method.
- Within the European Union:



EU-wide legislation, as implemented in each Member State, requires that waste electrical and electronic products carrying the mark (left) must be disposed of separately from normal household waste. This includes monitors and electrical accessories, such as signal cables or power cords. When you need to dispose of your display products, please follow the

guidance of your local authority, or ask the shop where you purchased the product. The mark on electrical and electronic products only applies to the current European Union Member States.

Please follow the national guidelines for electrical and electronic product disposal.

A.2 Maintenance and Cleaning Precautions

When maintaining or cleaning the ECW-281B/B2-D525, please follow the guidelines below.

A.2.1 Maintenance and Cleaning

Prior to cleaning any part or component of the ECW-281B/B2-D525, please read the details below.

 The interior of the ECW-281B/B2-D525 does not require cleaning. Keep fluids away from the ECW-281B/B2-D525 interior.

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- Be cautious of all small removable components when vacuuming the ECW-281B/B2-D525.
- Turn the ECW-281B/B2-D525 off before cleaning the ECW-281B/B2-D525.
- Never drop any objects or liquids through the openings of the ECW-281B/B2-D525.
- Be cautious of any possible allergic reactions to solvents or chemicals used when cleaning the ECW-281B/B2-D525.
- Avoid eating, drinking and smoking within vicinity of the ECW-281B/B2-D525.

A.2.2 Cleaning Tools

Some components in the ECW-281B/B2-D525 may only be cleaned using a product specifically designed for the purpose. In such case, the product will be explicitly mentioned in the cleaning tips. Below is a list of items to use when cleaning the ECW-281B/B2-D525.

- Cloth Although paper towels or tissues can be used, a soft, clean piece of cloth is recommended when cleaning the ECW-281B/B2-D525.
- Water or rubbing alcohol A cloth moistened with water or rubbing alcohol can be used to clean the ECW-281B/B2-D525.
- Using solvents The use of solvents is not recommended when cleaning the ECW-281B/B2-D525 as they may damage the plastic parts.
- Vacuum cleaner Using a vacuum specifically designed for computers is one of the best methods of cleaning the ECW-281B/B2-D525. Dust and dirt can restrict the airflow in the ECW-281B/B2-D525 and cause its circuitry to corrode.
- Cotton swabs Cotton swaps moistened with rubbing alcohol or water are excellent tools for wiping hard to reach areas.
- *Foam swabs* Whenever possible, it is best to use lint free swabs such as foam swabs for cleaning.





One Key Recovery









B.1 One Key Recovery Introduction

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The IEI one key recovery is an easy-to-use front end for the Norton Ghost system backup and recovery tool. The one key recovery provides quick and easy shortcuts for creating a backup and reverting to that backup or for reverting to the factory default settings.

The IEI One Key Recovery tool menu is shown below.



Figure B-1: IEI One Key Recovery Tool Menu

Prior to using the IEI One Key Recovery tool (as shown in **Figure B-1**) to backup or restore <u>Windows</u> system, five setup procedures are required.

- 1. Hardware and BIOS setup (see Section B.2.1)
- 2. Create partitions (see Section B.2.2)
- 3. Install operating system, drivers and system applications (see Section B.2.3)
- 4. Build-up recovery partition (see Section B.2.4)
- 5. Create factory default image (see Section B.2.5)

After completing the five initial setup procedures as described above, users can access the recovery tool by pressing **<F3>** while booting up the system. The detailed information of each function is described in **Section B.4**.



The initial setup procedures for Linux system are described in **Section B.3**.

B.1.1 System Requirement



The recovery CD can only be used with IEI products. The software will fail to run and a warning message will appear when used on non-IEI hardware.



To create the system backup, the main storage device must be split into two partitions (three partitions for Linux). The first partition will be for the operating system, while the second partition will be invisible to the operating system and contain the backup made by the one key recovery software.

The partition created for recovery images must be big enough to contain both the factory default image and the user backup image. The size must be calculated before creating the partitions. Please take the following table as a reference when calculating the size of the partition.

	os	OS Image after Ghost	Compression Ratio
Windows® 7	7 GB	5 GB	70%
Windows® XPE	776 MB	560 MB	70%
Windows® CE 6.0	36 MB	28 MB	77%



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Specialized tools are required to change the partition size if the operating system is already installed.

B.1.2 Supported Operating System

The recovery CD is compatible with both Microsoft Windows and Linux operating system (OS). The supported OS versions are listed below.

- Microsoft Windows
 - O Windows XP (Service Pack 2 or 3 required)
 - O Windows Vista
 - O Windows 7
 - O Windows CE 5.0
 - O Windows CE 6.0
 - O Windows XP Embedded
- Linux
 - O Fedora Core 12 (Constantine)
 - O Fedora Core 11 (Leonidas)
 - O Fedora Core 10 (Cambridge)
 - O Fedora Core 8 (Werewolf)
 - O Fedora Core 7 (Moonshine)
 - O RedHat RHEL-5.4
 - O RedHat 9 (Ghirke)
 - O Ubuntu 8.10 (Intrepid)
 - O Ubuntu 7.10 (Gutsy)
 - O Ubuntu 6.10 (Edgy)
 - O Debian 5.0 (Lenny)
 - O Debian 4.0 (Etch)
 - O SuSe 11.2
 - O SuSe 10.3



Installing unsupported OS versions may cause the recovery tool to fail.

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B.2 Setup Procedure for Windows

Prior to using the recovery tool to backup or restore Windows system, a few setup procedures are required.

- Step 1: Hardware and BIOS setup (see Section B.2.1)
- Step 2: Create partitions (see Section B.2.2)
- Step 3: Install operating system, drivers and system applications (see Section B.2.3)
- Step 4: Build-up recovery partition (see Section B.2.4)
- Step 5: Create factory default image (see Section B.2.5)

The detailed descriptions are described in the following sections.



The setup procedures described below are for Microsoft Windows operating system users. For Linux system, most setup procedures are the same with Microsoft Windows except for several steps which is described in **Section B.3**.

B.2.1 Hardware and BIOS Setup

- Step 1: Make sure the system is powered off and unplugged.
- **Step 2:** Install a hard drive or SSD in the system. An unformatted and unpartitioned disk is recommended.
- Step 3: Connect an optical disk drive to the system and insert the recovery CD.


Step 4: Turn on the system.

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- Step 5: Press the <DELETE> key as soon as the system is turned on to enter the BIOS.
- **Step 6:** Select the connected optical disk drive as the 1st boot device. (**Boot** \rightarrow **Boot Device Priority** \rightarrow 1st **Boot Device**).
- **Step 7:** Save changes and restart the computer. Continue to the next section for instructions on partitioning the internal storage.

B.2.2 Create Partitions

To create the system backup, the main storage device must be split into two partitions (three partitions for Linux). The first partition will be for the operating system, while the second partition will be invisible to the operating system and contain the backup made by the one key recovery software.

- Step 1: Put the recovery CD in the optical drive of the system.
- Step 2: Boot the system from recovery CD. When prompted, press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient!



Figure B-2: Launching the Recovery Tool

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Step 3: The recovery tool setup menu is shown as below.

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X:\I386\system32\cmd.exe	
1.Ghost Execution 2.System Configuration 3.System Configuration 4.Exit 5.CMD	For Windows For Linux
Type the number to prim	nt text

Figure B-3: Recovery Tool Setup Menu

Step 4: Press <5> then <Enter>.



Figure B-4: Command Mode

 Step 5:
 The command prompt window appears. Type the following commands (marked in red) to create two partitions. One is for the OS installation; the other is for saving recovery files and images which will be an invisible partition.

 (Press <Enter> after entering each line below)

 system32>diskpart

 DISKPART>list vol

 DISKPART>create part pri size= ____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= _____

 DISKPART>create part pri size= ______

 DISKPART>create part pri size= _______

 DISKPART>create part pri size= _______

 DISKPART>create part pri size= ________

 DISKPART>create part pri size= _________

 DISKPART>create part pri size= _________

 DISKPART>create part pri size= __________

 DISKPART>create part pri size= __________

 DISKPART>create part pri size= ____________

 DISKPART>exit

 system32>format N: /fs:ntfs /q /y





system32>format F: /fs:ntfs /q /v:Recovery /y

system32>exit

👞 X:\I386\system	132\CM	ID.EXE					_ [5	1×
X:\I386\\$YSTE	M32>d	iskpart 🔶	Starts th	e Microsoft dis	k partitioni	ng tool.		
Microsoft Dis Copyright (C) On computer:	kPart 1999 MININ	version 5.2 -2001 Micros T-JVC	.3790.18 oft Corp	30 poration.				
DISKPART> lis	t vol	→ Show pa	artition in	formation				
Volume ###	Ltr	Label	Fs	Туре	Size	Status	Info	
Volume Ø Volume 1	X D	CD_ROM	CDFS FAT32	DVD-ROM Removeable	405 MB 3854 MB	Healthy Healthy	Boot	
DISKPART> sel	disk	0	ct a disk					
Disk Ø is now	the	selected dis	k.					
DISKPART> cre	ate p	art pri size	= <mark>2000 -</mark>	Create pa This parti	rtition 1 an	d assign a s OS installation	ize.	
DiskPart succ	eeded	in creating	the spe	cified parti	tion.			
DISKPART> ass	ign l	etter=N	Assign p	partition 1 a co	de name (N			
DiskPart succ	essfu	lly assigned	the dri	ive letter or	mount po	int.		
DISKPART> cre	ate p	art pri size	=1800	Create partition This partition	rtition 2 and	d assign a si	ize.	
DiskPart succ	eeded	in creating	the spe	cified parti	tion.	coovery mia	geo.	
DISKPART> ass	ign l	etter=F	- Assign	partition 2 a co	de name (F	·).		
DiskPart succ	essfu	lly assigned	the dri	ive letter or	mount po	int.		
DISKPART> <mark>e</mark> xi	t	Exit diskpar						
X:\I386\SYSTE The type of t The new file QuickFormatti Creating file Format comple 2048254 KB 2035620 KB	M32)f he fi syste ng 20 syst te. tota are	ormat n: /fs 1e system 1s m is NTFS. 00M em structure 1 disk space available.	∶ntfs ⁄q _KHW. s.	r ∠y —→ Forn	mat partitic	on 1 (N) as N	TFS format.	
X:\I386\SYSTE The type of t The new file QuickFormatti Creating file Format comple 1847474 KB 1835860 KB	M32)f he fi syste ng 18 syst te. tota are	ormat f: /fs ie system is m is NTFS. 04M em structure l disk space available.	s.	Formate par name it as "	tition 2 (F) Recovery".	as NTFS for	mate and	
X:/I386/SYSTE	M32)e	xit 💦 🚬 EXII	WINdows					

Figure B-5: Partition Creation Commands





Use the following commands to check if the partitions were created successfully.

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Microsoft DiskPa Copyright (C) 19 On computer: MIN	rt version 5.2.379 99-2001 Microsoft INT-JVC	90.1830 Corporati	lon.
DISKPART> sel di	sk Ø		
Disk Ø is now th	e selected disk.		
Mitter and Market and Market and Market and			
DISKPART> list p	art		
DISKPART> list p Partition ###	art Type	Size	Offset
DISKPART> list p Partition ### Partition 1 Partition 2	art Type Primary Primary	Size 2000 MB 1804 MB	Offset 32 KE 2000 ME

Step 6: Press any key to exit the recovery tool and automatically reboot the system. Please continue to the following procedure: Build-up Recovery Partition.

B.2.3 Install Operating System, Drivers and Applications

Install the operating system onto the unlabelled partition. The partition labeled as "Recovery" is for use by the system recovery tool and should not be used for installing the operating system or any applications.



The operating system installation program may offer to reformat the chosen partition. DO NOT format the partition again. The partition has already been formatted and is ready for installing the new operating system.

To install the operating system, insert the operating system installation CD into the optical drive. Restart the computer and follow the installation instructions.





B.2.4 Build-up Recovery Partition

- **Step 1:** Put the recover CD in the optical drive.
- Step 2: Start the system.
- Step 3: Boot the system from recovery CD. When prompted, press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient!



Figure B-6: Launching the Recovery Tool

Step 4: When the recovery tool setup menu appears, press <2> then <Enter>.



Figure B-7: System Configuration for Windows

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Step 5: The Symantec Ghost window appears and starts configuring the system to

build-up a recovery partition. In this process, the partition which is created for

recovery files in Section B.2.2 is hidden and the recovery tool is saved in this

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partition.



Figure B-8: Build-up Recovery Partition

Step 6: After completing the system configuration, press any key in the following window

to reboot the system.

📾 X:\I386\system32\cmd.exe	
1.Ghost Execution 2.System Configuration 3.System Configuration 4.Exit	For Windows For Linux
5.CMD Type the number to pri Press any key to conti	nt text.2 nue

Figure B-9: Press any key to continue







B.2.5 Create Factory Default Image



Before creating the factory default image, please configure the system to a factory default environment, including driver and application installations.

To create a factory default image, please follow the steps below.

Step 1: Turn on the system. When the following screen displays (Figure B-10), press the <F3> key to access the recovery tool. The message will display for 10 seconds, please press F3 before the system boots into the operating system.



Figure B-10: Press F3 to Boot into Recovery Mode

Step 2: The recovery tool menu appears. Type <4> and press <Enter>. (Figure B-11)



Figure B-11: Recovery Tool Menu

Step 3: The About Symantec Ghost window appears. Click OK button to continue.





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Figure B-12: About Symantec Ghost Window

Step 4: Use mouse to navigate to the option shown below (Figure B-13).



Figure B-13: Symantec Ghost Path

Step 5: Select the local source drive (Drive 1) as shown in Figure B-14. Then click OK.



Drive	Location	Model	Size(MB)	Туре	Cylinders	Heads	Sectors
1	Local	ST3160318AS	152627	Balsic	19457	255	63
80	Local	US VOILITIES	120128	Basic	15314	255	63

Figure B-14: Select a Local Source Drive

Step 6: Select a source partition (Part 1) from basic drive as shown in Figure B-15.

Then click OK.

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Part	Type	Letter	ID	Description	Label	oize in MB	in MB
1	0		07	NTFS	No name	100006	1951
2	U		07	NIFS	Necovery Free	20002 32618	917
					Total	152627	2178



Step 7: Select 1.2: [Recovery] NTFS drive and enter a file name called iei

(**Figure B-16**). Click **Save**. The factory default image will then be saved in the selected recovery drive and named IEI.GHO.



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The file name of the factory default image must be **iei.GHO**.

Look jn: 1 🗔 D: 1.2: [Red	covery] NTFS dri	ve 🔻 主	₽*
Name	Size	Date	
BOOT EFI		01/03/2010 05:00:52 01/03/2010 05:01:02	am Am
Recovery		01/03/2010 05:57:16	AM
		01/03/2010 05:02:16	RM DL
2		3	
File <u>n</u> ame: 2 iel		3	ve
File <u>name</u> : 2 iel Files of <u>typ</u> e: *.GH0		3 Sau ∑an	ve cel

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Figure B-16: File Name to Copy Image to

Step 8: When the Compress Image screen in Figure B-17 prompts, click High to make

the image file smaller.



Figure B-17: Compress Image





The Proceed with partition image creation window appears, click Yes to Step 9:

continue.

Questio	n: (1837)
?	Proceed with partition image creation?
	<u>Y</u> es <u>N</u> o

Figure B-18: Image Creation Confirmation

Progress Indicator				
0%	25%	50%	75%	100%
Statistics				
Percent complete	52		- 1.1	
Speed (MB/min)	468		× (
MB copied	632		N	7
MB remaining	563		1	1
Time elapsed	1:21		1	/
Time remaining	1:12			·
Details				
Connection type	Local			
Source Partition	Type:7 ENTFS], 10	0006 MB, 1951 MB used	, No name	
	from Local drive [8	30], 130129 MB		
Destination file	Local file D:\iei.GHO			
Current file	3891 c_869.nls			

Figure B-19: Image Creation Process

Step 11: When the image creation completes, a screen prompts as shown in Figure B-20.

Click **Continue** and close the Ghost window to exit the program.

Image	Creation Complete (1925)
8	Image Creation Completed Successfully
	<u>C</u> ontinue

Figure B-20: Image Creation Complete



Step 10: The Symantec Ghost starts to create the factory default image (Figure B-19).

Step 12: The recovery tool main menu window is shown as below. Press any key to

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reboot the system.



Figure B-21: Press Any Key to Continue

B.3 Setup Procedure for Linux

The initial setup procedures for Linux system are mostly the same with the procedure for Microsoft Windows. Please follow the steps below to setup recovery tool for Linux OS.

- Step 1: Hardware and BIOS setup. Refer to Section B.2.1.
- Step 2: Install Linux operating system. Make sure to install GRUB (v0.97 or earlier) MBR type and Ext3 partition type. Leave enough space on the hard drive to create the recover partition later.



If the Linux OS is not installed with GRUB (v0.97 or earlier) and Ext3, the Symantec Ghost may not function properly.

While installing Linux OS, please create two partitions:

- Partition 1: I
- Partition 2: SWAP







Please reserve enough space for partition 3 for saving recovery images.

Partition 1	Partition 2	* Recovery Partit	tion 3
s/hda1	s/hda2	s/hda3	()
•Point : /	•Type : SWAP	•Recovery Mode	
•Type : Ext3		•Recovery Image	\bigcirc

Figure B-22: Partitions for Linux

Step 3: Create a recovery partition. Insert the recovery CD into the optical disk drive. Follow Step 1 ~ Step 3 described in Section B.2.2. Then type the following commands (marked in red) to create a partition for recovery images. system32>diskpart DISKPART>list vol DISKPART>sel disk 0 DISKPART>create part pri size= ____ DISKPART>assign letter=N DISKPART>exit system32>format N: /fs:ntfs /q /v:Recovery /y

system32>exit

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Step 4: Build-up recovery partition. Press any key to boot from the recovery CD. It will take a while to launch the recovery tool. Please be patient. When the recovery tool setup menu appears, type <3> and press <Enter> (Figure B-23). The Symantec Ghost window appears and starts configuring the system to build-up a recovery partition. After completing the system configuration, press any key to reboot the system. Eject the recovery CD.



X:\I386\system32\cmd.exe 1.Ghost Execution 2.System Configuration For Windows 3.System Configuration For Linux 4.Exit 5.CMD Type the number to print text.3



Step 5: Access the recovery tool main menu by modifying the "menu.lst". To first

access the recovery tool main menu, the menu.lst must be modified. In Linux

system, enter Administrator (root). When prompt appears, type:

cd /boot/grub

vi menu.lst

Fedora	relea	se 9 (Sulpl	nur)			
Kernel	2.6.2	5-14.f	c9.it	o86 o	n an	1686	(tty2)
localho Passwor	ost lo rd:	gin: r	oot				
[root@ [root@	localh localh	ost ~] ost gr	# cd ub]#	∕boo vi m	t∕gru enu.l	ıb∕ lst _	

Figure B-24: Access menu.lst in Linux (Text Mode)

Step 6: Modify the menu.lst as shown below.





Step 7: The recovery tool menu appears. (Figure B-25)





Step 8: Create a factory default image. Follow Step 2 ~ Step 12 described in Section

B.2.5 to create a factory default image.

B.4 Recovery Tool Functions

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After completing the initial setup procedures as described above, users can access the recovery tool by pressing $\langle F3 \rangle$ while booting up the system. The main menu of the recovery tool is shown below.



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Figure B-26: Recovery Tool Main Menu

The recovery tool has several functions including:

- Factory Restore: Restore the factory default image (iei.GHO) created in Section B.2.5.
- Backup system: Create a system backup image (iei_user.GHO) which will be saved in the hidden partition.
- 3. Restore your last backup: Restore the last system backup image
- 4. Manual: Enter the Symantec Ghost window to configure manually.
- 5. Quit: Exit the recovery tool and restart the system.



Please do not turn off the system power during the process of system recovery or backup.



All data in the system will be deleted during the system recovery. Please backup the system files before restoring the system (either Factory Restore or Restore Backup).





B.4.1 Factory Restore

To restore the factory default image, please follow the steps below.

- **Step 1:** Type <1> and press <**Enter**> in the main menu.
- Step 2: The Symantec Ghost window appears and starts to restore the factory default. A

factory default image called **iei.GHO** is created in the hidden Recovery partition.

0%	25%	50%	75%	100%
Statistics				
Percent complete	45		- 1.1	
Speed (MB/min)	1125		· · · · · ·	
MB copied	544		1	7
MB remaining	651		1	1
Time elapsed	0:29		1	/
Time remaining	0:34			·
Details				
Connection type	Local			
Source Partition	Type:7 [NTFS], 10 from Local file D:\	0006 MB, 1951 MB used iei.oho. 130129 MB	, No name	
Target Partition	Tupe:7 [NTFS], 10	0006 MB		
	from Local drive [13. 152627 MB		
Current file	3279 vpob2res dll			

Figure B-27: Restore Factory Default

Step 3: The screen is shown as in Figure B-28 when completed. Press any key to

reboot the system.



Figure B-28: Recovery Complete Window

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B.4.2 Backup System

To backup the system, please follow the steps below.

- **Step 1:** Type <**2**> and press <**Enter**> in the main menu.
- Step 2: The Symantec Ghost window appears and starts to backup the system. A

backup image called **iei_user.GHO** is created in the hidden Recovery partition.

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25%	50%	75%	100%
45		- 1.1	
212		2.1	
548		1	
647		1	1
2:35		1	/
3:03			·
Local			
Type:7 [NTFS], 10	0006 MB, 1951 MB used	, No name	
from Local drive E	13, 152627 MB		
Local file D:\iei_us	er.gho		
3288 xpob2res.dll			
	Syma	antec.	
	25% 45 212 548 647 235 303 303 Local Type:7 [NTF\$], 10 from Local drive E Local drive E Local drive E Local drive E	25% 50% 45 212 548 647 2:35 3:03 3:03 Cocal Type:7 (NTFS], 100006 HB, 1951 HB used from Local drive [1], 152627 HB Local file D:\iei_user.gho 3288 xpob2res.dll	25% 50% 75% 45 518 647 235 303 50% 303 511 HB used, No name from Local drive (11, 152627 HB Local file DtNiei_user.gho 3288 wpob2res.dll

Figure B-29: Backup System

Step 3: The screen is shown as in Figure B-30 when system backup is completed.

Press any key to reboot the system.



Figure B-30: System Backup Complete Window





B.4.3 Restore Your Last Backup

To restore the last system backup, please follow the steps below.

- Step 1: Type <3> and press <Enter> in the main menu.
- Step 2: The Symantec Ghost window appears and starts to restore the last backup

image (iei_user.GHO).

Progress Indicator				
0%	25%	50%	75%	100%
Statistics				
Percent complete	45		- 1.1	
Speed (MB/min)	212		~···	
MB copied	548		1	-7
MB remaining	647		1	1
Time elapsed	2:35		1	/
Time remaining	3:03			/
Details				
Connection type	Local			
Source Partition	Type:7 [NTFS], 10	0006 MB, 1951 MB used	, No name	
	from Local drive E	1], 152627 MB		
Destination file	Local file D:\iei_us	er.gho		
Current file	3288 xpob2res.dll			
urrent file	3288 xpob2res.dll			

Figure B-31: Restore Backup

Step 3: The screen is shown as in Figure B-32 when backup recovery is completed.

Press any key to reboot the system.



Figure B-32: Restore System Backup Complete Window

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B.4.4 Manual

To restore the last system backup, please follow the steps below.

- **Step 1:** Type <**4**> and press **<Enter**> in the main menu.
- **Step 2:** The Symantec Ghost window appears. Use the Ghost program to backup or recover the system manually.

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Sym	anteo Grost 1	L.5 Copyright (C	1998-2008 Syma	ntee Corporation. A	ll rights reserved.	
F	Local	N				
	Decidences					
	Teer to peer					
	gnosicasi					
10	<u>Options</u>					
nanie	jieip					
ĝ	Jut					
			4	a comanta		
			0	J symantee	**:;	

Figure B-33: Symantec Ghost Window

Step 3: When backup or recovery is completed, press any key to reboot the system.





B.5 Other Information

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B.5.1 Using AHCI Mode or ALi M5283 / VIA VT6421A Controller

When the system uses AHCI mode or some specific SATA controllers such as ALi M5283 or VIA VT6421A, the SATA RAID/AHCI driver must be installed before using one key recovery. Please follow the steps below to install the SATA RAID/AHCI driver.

- Step 1: Copy the SATA RAID/AHCI driver to a floppy disk and insert the floppy disk into a USB floppy disk drive. The SATA RAID/AHCI driver must be especially designed for the on-board SATA controller.
- Step 2: Connect the USB floppy disk drive to the system.
- Step 3: Insert the One Key Recovery CD into the system and boot the system from the CD.
- Step 4: When launching the recovery tool, press <F6>.



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Step 5: When the following window appears, press <S> to select "Specify Additional"

Device".

Setup could not determine the type of one or more mass storage devices installed in your system, or you have chosen to manually specify an adapter. Currently, Setup will load support for the following mass storage devices(s):

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(none)

- To specify additional SCS1 adapters, CD-ROM drives, or special disk controllers for use with Windows, including those for which you have a device support disk from a mass storage device manufacturer, press S.
- If you do not have any device support disks from a mass storage device manufacturer, or do not want to specify additional mass storage devices for use with Windows, press ENTER.

S=Specify Additional Device ENTER=Continue F3=Exit

Step 6: In the following window, select a SATA controller mode used in the system. Then

press < Enter>. The user can now start using the SATA HDD.





Step 7: After pressing <Enter>, the system will get into the recovery tool setup menu.
 Continue to follow the setup procedure from Step 4 in Section B.2.2 Create
 Partitions to finish the whole setup process.

B.5.2 System Memory Requirement

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To be able to access the recovery tool by pressing **<F3>** while booting up the system, please make sure to have enough system memory. The minimum memory requirement is listed below.

- Using Award BIOS: 128 MB system memory
- Using AMI BIOS: 512 MB system memory.





BIOS Menu Options





C.1 BIOS Configuration Options

Below is a list of BIOS configuration options described in **Chapter 5**.

BIOS Information	3
System Date [xx/xx/xx]	3
System Time [xx:xx:xx]	4
ACPI Sleep State [S1 (CPU Stop Clock)]55	5
Hyper Threading [Enabled]57	7
ATA/IDE Configurations [Enhanced]57	7
Configure SATA as [IDE]58	B
USB Devices	9
Legacy USB Support [Enabled]59	9
Serial Port [Enabled]60	D
Change Settings [Auto]60	D
Serial Port [Enabled]61	1
Change Settings [Auto]61	1
Serial Port [Enabled]61	1
Change Settings [Auto]62	2
Serial Port [Enabled]62	2
Change Settings [Auto]62	2
Serial Port [Enabled]63	3
Change Settings [Auto]63	3
Serial Port [Enabled]64	4
Change Settings [Auto]64	4
PC Health Status65	5
CPU Smart Fan control [Auto Mode]66	6
Console Redirection [Disabled]67	7
Terminal Type [ANSI]67	7
Bits per second [115200]68	B
Auto Recovery Function [Disabled]68	B
Initiate Graphic Adapter70	D
Share Memory Size [8 MB]71	1
Multi-Monitor Support [Enabled]71	1
Restore on AC Power Loss [Last State]72	2

HD Audio Controller [Enabled]72
USB Function [Enabled]73
USB 2.0 (EHCI) Support [Enabled]73
Set Spread Spectrum Function [Disabled]73
DVMT Mode Select [DVMT Mode]74
DVMT/FIXED Memory [256 MB]74
IGD - Boot Type [VBIOS Default]74
LCD Panel Type [VBIOS Default]75
Bootup NumLock State [On]76
Quiet Boot [Enabled]76
Launch PXE OpROM [Disabled]76
Administrator Password77
User Password77
Save Changes and Reset78
Discard Changes and Reset78
Restore Defaults78
Save as User Defaults78
Restore User Defaults

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Watchdog Timer





The following discussion applies to DOS environment. IEI support is contacted or the IEI website visited for specific drivers for more sophisticated operating systems, e.g., Windows and Linux.

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The Watchdog Timer is provided to ensure that standalone systems can always recover from catastrophic conditions that cause the CPU to crash. This condition may have occurred by external EMI or a software bug. When the CPU stops working correctly, Watchdog Timer either performs a hardware reset (cold boot) or a Non-Maskable Interrupt (NMI) to bring the system back to a known state.

A BIOS function call (INT 15H) is used to control the Watchdog Timer:

AH – 6FH Sub-function:		
AL – 2:	Sets the Watchdog Timer's period.	
BL:	Time-out value (Its unit-second is dependent on the item "Watchdog	
	Timer unit select" in CMOS setup).	

INT 15H:

Table D-1: AH-6FH Sub-function

Call sub-function 2 to set the time-out period of Watchdog Timer first. If the time-out value is not zero, the Watchdog Timer starts counting down. While the timer value reaches zero, the system resets. To ensure that this reset condition does not occur, calling sub-function 2 must periodically refresh the Watchdog Timer. However, the Watchdog timer is disabled if the time-out value is set to zero.

A tolerance of at least 10% must be maintained to avoid unknown routines within the operating system (DOS), such as disk I/O that can be very time-consuming.







When exiting a program it is necessary to disable the Watchdog Timer, otherwise the system resets.

Example program:

; INITIAL TIMER PERIOD COUNTER

W_LOOP:

;

;

;

MOV	AX, 6F02H	;setting the time-out value
MOV	BL, 30	; time-out value is 48 seconds
INT	15H	

; ADD THE APPLICATION PROGRAM HERE

CMP	EXIT_AP, 1	; is the application over?
JNE	W_LOOP	; No, restart the application
MOV	AX, 6F02H	;disable Watchdog Timer
MOV	BL, 0	;
INT	15H	

;

; **EXIT** ;

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